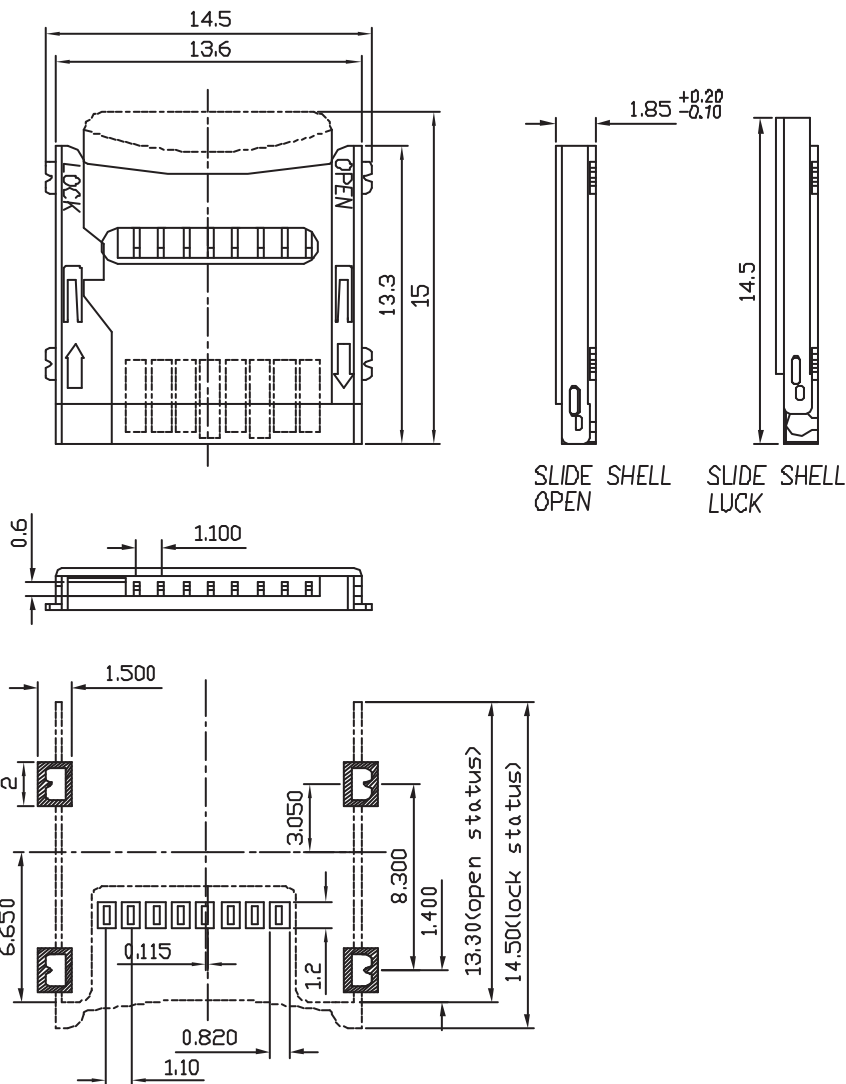


1 2 3 4 5 6 7 8

| REV | MODIFICATION | DATE | DRAW |
|-----|--------------|------|------|
| | | | |
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F
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Specification:

Withstanding Voltage: 500VAC Max with 1 Minute
 Insulation Resistance: 1000MΩ min
 Ratings
 Voltage : 100 Volts DC, AC(rms) 100 Volts (per pin)
 Current : 0.5 Amperes DC (per pin)
 Operating Temperature : -25C~+85C
 Contact Retaintion Force: 100 Gram(0.98N) min
 Insertion Force: 15N Max
 Sepatation Force: 15N Max
 Insertion Cycles: 5000Times

Ordering Information:

TFDMF-108 XX BT00
 05-- 5u" Gold Plating
 10-- 10u" Gold Plating
 15-- 15u" Gold Plating

REFERENCE PCB LAYOUT

| | | | | |
|--------------------------------------|-------|-------------|---|-------------------------|
| DIMENSION IN mm [Inch] | | PROD. SPEC. | ALMITA CO., LTD. | |
| TOLERANCE UNLESS OTHERWISE SPECIFIED | | PKG. SPEC. | TITLE TRANS FLASH CARD CONNECTOR HINGE TYPE | CUSTOMER DRAWING |
| .X±0.05 | X'± | APPROVE | FILE NO. | DWG NO. TFDMF-108XXBT00 |
| .XX±0.05 | .X'± | CHECK | SIZE A4 | PROJ. SHEET 1 / 1 |
| .XXX±0.05 | .XX'± | DRAW | SCALE 3:1 | REV A |

1 2 3 4 5 6 7 8 8F-01-R10